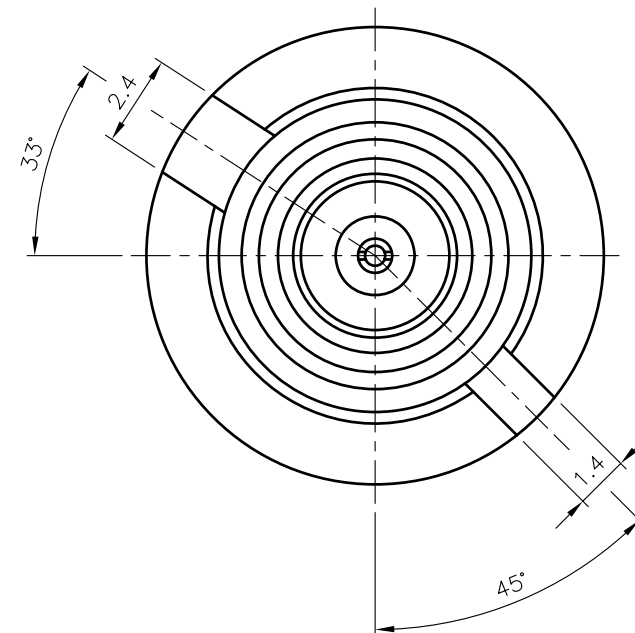
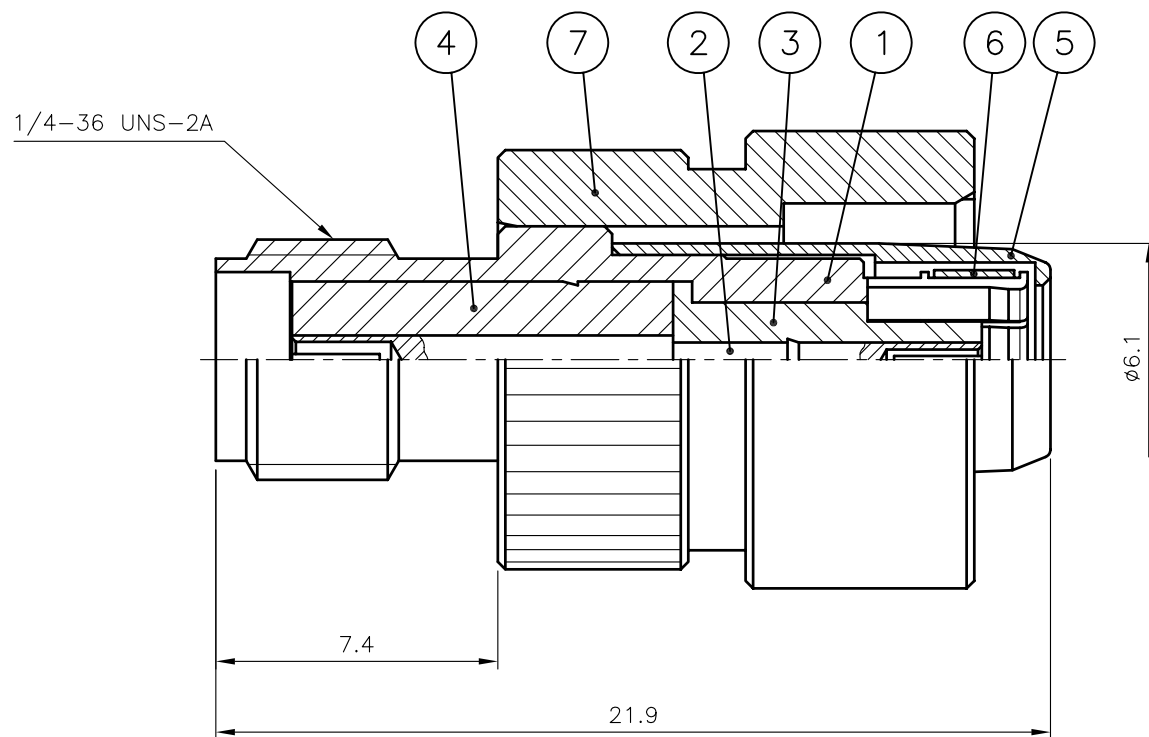


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2014.06.27.
1	[설번처리No.201811-0001] 절연체 분할 구조 변경	I.C.KIM		2018.11.13.



주 기

1. FAKRA I Type CODING
2. PIN 조립 시 ③번 절연체 밀림 없는지 확인 후 조립 할 것
(밀림 발생시 하단 지그대고 작업)

** Keying Type & Color Table**

Fig.	
Type	I

7	CODING KEY CAP	1	MBsBD	Gold Plate	DCU02244-5/1
6	SPRING RING	1	BeCu	Copper Plate	DSR00009-5/1
5	CAP	1	MBsBD	Gold Plate	DCU02195-5/2
4	INSULATOR	1	TEFLON		DIN01014-N/1
3	INSULATOR	1	TEFLON		DAI00119-N/1
2	CONTACT	1	BeCu	Gold Plate	DAC00207-5/1
1	BODY	1	MBsBD	Gold Plate	DAD00212-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2018. 11. 13.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY		
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 (J) SMB50 (J) ST ADAPTOR
		DRAWN BY	I.C.KIM	
FINISH		SCALE	5/1	A4 DWG NO. AD00524-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	